

DECLARATION

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As the below-named inventors, we declare that:

Our residences, post office addresses, and citizenships are as stated below under our names.

We believe we are the original, first, and joint inventors of the subject matter claimed and for which a patent is sought on the invention entitled "FABRICATION OF STACKED MICROELECTRONIC DEVICES" in the foregoing specification and claims.


We have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

We acknowledge our duty to disclose information which is material to the patentability of this application in accordance with 37 C.F.R. § 1.56(a).

We further declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that the making of willfully false statements and the like is punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and may jeopardize the validity of any patent issuing from this patent application.


Michael ConnellDate 1/7/02

Residence : City of Boise
State of Idaho
Citizenship : United States of America
P.O. Address : 450 Grove Street, #409
Boise, Idaho 83702



Tongbi Jiang

Date 11/7/02

Residence : City of Boise
State of Idaho
Citizenship : United States of America
P.O. Address : 12036 W. Patrina Dr.
Boise, Idaho 83713

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11/7/02 11:00 AM 11/7/02 11:00 AM 11/7/02 11:00 AM

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Michael Connell
Tongbi JiangDocket No.: 108298638US
Disclosure Number: 01-0431

Filed: Concurrently herewith

For: FABRICATION OF STACKED
MICROELECTRONIC
DEVICES

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ASSIGNMENT:

☒ Enclosed for recording
☐ Previously recorded

Date: _____

Reel: _____

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled "FABRICATION OF STACKED MICROELECTRONIC DEVICES"; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.


Michael Connell

Date:

1/7/02

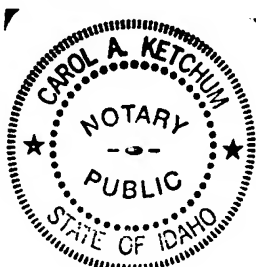
BEST AVAILABLE


STATE OF IDAHO)

County of Ada) ss.

BEFORE ME, this 7th day of January, 2002, personally appeared the above-named individual, to me known to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he executed the same of his own free will for the purpose therein expressed.

SEAL




Notary or Consular Officer
My Commission Expires 05/24/07

Tongbi Jiang
Tongbi Jiang

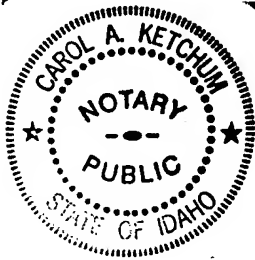
Date: 1/7/02

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County of Ada) ss.

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SEAL



Carol A. Ketchum
Notary or Consular Officer
My Commission Expires 05/24/07

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Michael Connell and Tongbi Jiang
Filed : Concurrently herewith
For : FABRICATION OF STACKED MICROELECTRONIC
DEVICES

Docket No. : 108298638US

Box Patent Application
Assistant Commissioner for Patents
Washington, DC 20231

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ELECTION UNDER 37 C.F.R. §§ 3.71 AND 3.73 AND POWER OF
ATTORNEY

Sir:

The undersigned, being Assignee of the entire interest in the above-identified application by virtue of an Assignment filed concurrently herewith, hereby elects, under 37 C.F.R. § 3.71, to prosecute the application to the exclusion of the inventors.

Assignee hereby appoints JERRY A. RIEDINGER, Registration No. 30,582; MAURICE J. PIRIO, Registration No. 33,273; MICHAEL D. BROADDUS, Registration No. 41,637; CATHERINE HONG TRAN, Registration No. 43,960; ROBERT G. WOOLSTON, Registration No. 37,263; PAUL T. PARKER, Registration No. 38,264; JOHN M. WECHKIN, Registration No. 42,216; CHRISTOPHER DALEY-WATSON, Registration No. 34,807; STEVEN D. LAWRENZ, Registration No. 37,376; JAMES A.D. WHITE, Registration No. 43,985; EDWARD S. HOTCHKISS, Registration No. 33,904; JAMES NICKELSON, Registration No. 46,140; STEPHEN E. ARNETT, Registration No. 47,392; DAVINA L. CHILDS, Registration No. 47,485; BRETON A. BOCCHIERI, Registration No. 31,739; BARBARA B. COURTNEY, Registration No. 42,442; PETER J. DEHLINGER, Registration No. 28,006; LEE ANN

GORTHEY, Registration No. 37,337, RICHARD L. GREGORY, Registration No. 42,607, LINDA R. JUDGE, Registration No. 42,702, MICHAEL MARTENSEN, Registration No. 46,901, JUDY M. MOHR, Registration No. 38,563, MARK A. THOMAS, Registration No. 37,953, and LARRY THROWER, Registration No. 47,994 of Perkins Coie LLP, along with MICHAEL L. LYNCH, Reg. No. 30,871; CHARLES B. BRANTLEY, II, Reg. No. 38,086; KEVIN D. MARTIN, Reg. No. 37,882; and DAVID J. PAUL, Reg. No. 34,692, of Micron Technology, Inc., 8000 South Federal Way, Boise, Idaho 83706-9632 as the principal attorneys with full power of substitution, association, and revocation to prosecute said application, to transact all business in the Patent and Trademark Office connected therewith, and to receive the letters patent therefor. Please direct all direct all telephone calls to Mr. Edward S. Hotchkiss at (206) 583-8888 and telecopies to (206) 583-8500.

Please direct all communications to:


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Patent-SEA
Perkins Coie LLP
P. O. Box 1247
Seattle, Washington 98111-1247
Attn: Edward S. Hotchkiss

Pursuant to 37 C.F.R. § 3.73, the undersigned duly authorized designee of Assignee certifies that the evidentiary documents have been reviewed, specifically the Assignment to MICRON TECHNOLOGY, INC., filed concurrently herewith for recording, a copy of which is attached hereto, and certifies that to the best of my knowledge and belief, title remains in the name of the Assignee.

MICRON TECHNOLOGY, INC.

1-14-2002
DATE


Michael L. Lynch
Chief Patent Counsel

Enclosure:

Copy of Assignment